IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					erials and I	ials and Mfg Information			
upplier Infor	mation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2025-0	2025-05-14			
Contact Name		Title - Contact			1	Phone - Contact*				Email	Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Repre	sentative*	Title - Representative			1	Phone - Representative*				Email	Email - Representative*				
Product-Env-Stev	wards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Reques	ster Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Versio	n	Manufacturing Site		Weight*	UOM	Unit Type	
		FAN739	AN73912AMX 1200V High-Current, Gate-Driver IC		ent, High & Lo	w-side,	2025-05-14			TAD		439.711	mg	Each	
<b>I</b> anufacturing	g Proccess Information	on													
Terminal Plating / Grid Array Material			Ferminal Base Alloy J-STD-020 MS		L Rating	Peak Process Body Temperature   Max Time at Pe		ak Temperature Number of Reflow Cycles							
Matte Tin (Sn) - annealed		C	CU Alloy 3		3		260		C	30	seco	onds 3			
omments															
TTENTION: M	SL 3 Rated item requires l	Bake and D	ry Pack (afte	r electrical test)											
or more informa	tion regarding material co	mposition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale a											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.06	mg	Supplier	Silicon (Si)	7440-21-3		4.06	mg
Die Attach	1.25	mg		Epoxy resin	proprietary data		0.125	mg
			Supplier	Silver (Ag)	7440-22-4		1	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.125	mg
Lead Frame	140.481	mg	Supplier	Silver (Ag)	7440-22-4		4.917	mg
			Supplier	Zinc (Zn)	7440-66-6		0.271	mg
			Supplier	Iron (Fe)	7439-89-6		3.254	mg
			Supplier	Copper (Cu)	7440-50-8		131.903	mg
			Supplier	Phosphorus (P)	7723-14-0		0.136	mg
Mold Compound-Black	280.5	mg		Epoxy resin	proprietary data		19.635	mg
			Supplier	Phenolic Resin	Proprietary Data		8.415	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		16.83	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		28.05	mg
			Supplier	Carbon Black (C)	1333-86-4		4.2075	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		203.3625	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		-272.085	mg
Plating	13.17	mg	Supplier	Tin (Sn)	7440-31-5		13.17	mg
Wire Bond	0.25	mg	Supplier	Palladium (Pd)	7440-05-3		0.0025	mg
			Supplier	Copper (Cu)	7440-50-8		0.2475	mg